

# **D1FM3**

# **Schottky Barrier Diodes 30V, 5A**

#### **Feature**

- Small SMD
- · High Recovery Speed
- Low V<sub>F</sub>
- · Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

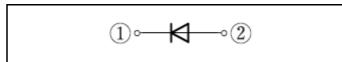
## **OUTLINE**

Package (House Name): 1F

Package (JEDEC Code): DO-214AC



# **Equivalent circuit**



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperrature	Tstg		-55 to 150	°C
Junction temperature	Tj		-55 to 150	°C
Repetitive peak reverse voltage	$V_{RRM}$		30	٧
Average forward current	I <sub>F</sub> (AV)	50Hz sine wave, Resistance load, On glass-epoxy substrate, Tc=83°C *	5	А
Average forward current	I <sub>F</sub> (AV)	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=25°C *	3	Α
Surge forward current	I <sub>FSM</sub>	50Hz sine wave, Non-repetitive, 1cycle, Peak value, Tj=25°C	90	А

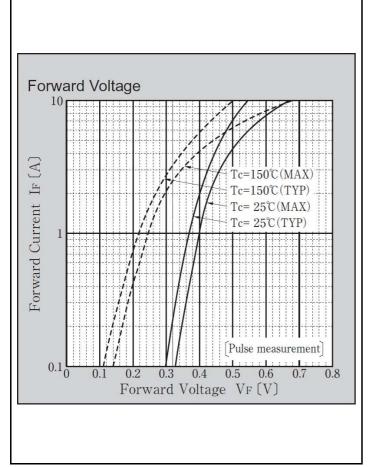
<sup>\* :</sup>See the original Specifications

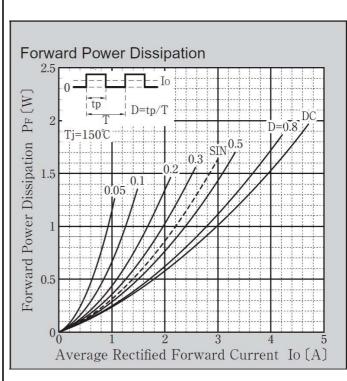
# **Electrical Characteristics** (unless otherwise specified : Tc=25°C)

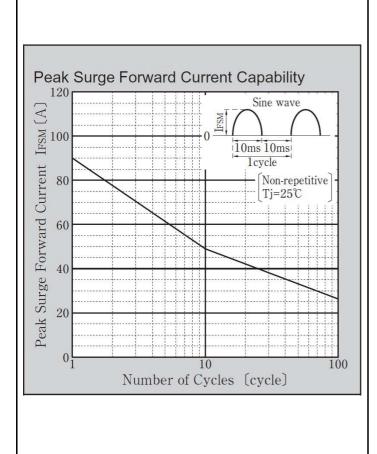
Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V <sub>F</sub>	IF=3.0A, Pulse measurement			0.46	V
Forward voltage	V <sub>F</sub>	IF=1.0A, Pulse measurement			0.4	V
Reverse current	I <sub>R</sub>	VR=30V, Pulse measurement			0.1	mA
Total capacitance	Ct	f=1MHz, VR=10V		130		pF
Thermal resistance	Rth(j-c)	Junction to case *			16	°C/W
Thermal resistance	Rth(j-l)	Junction to lead, On glass-epoxy substrate *			18	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate *			65	°C/W

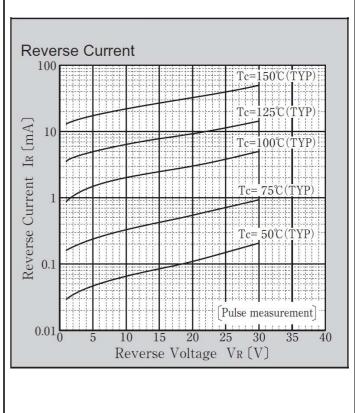
<sup>\*</sup> :See the original Specifications

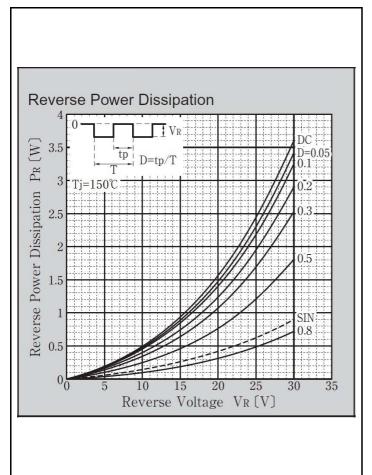
# **CHARACTERISTIC DIAGRAMS**

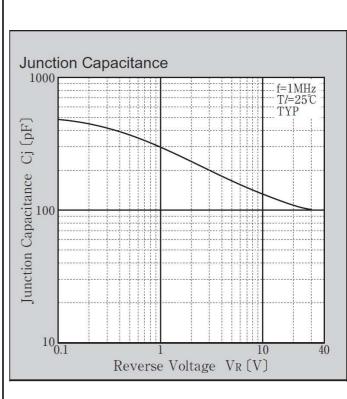


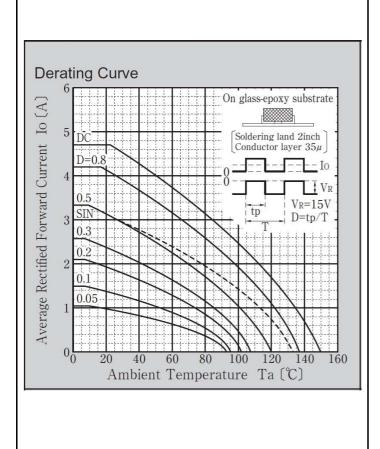


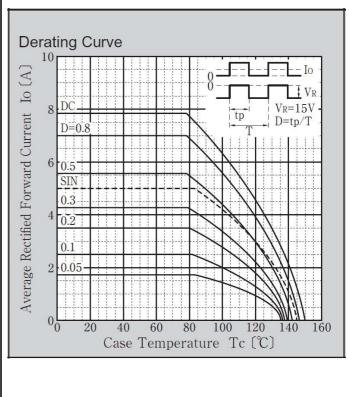


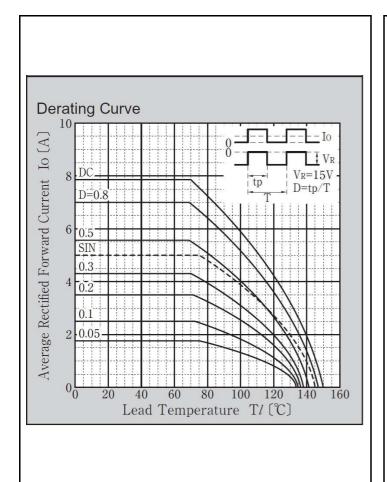


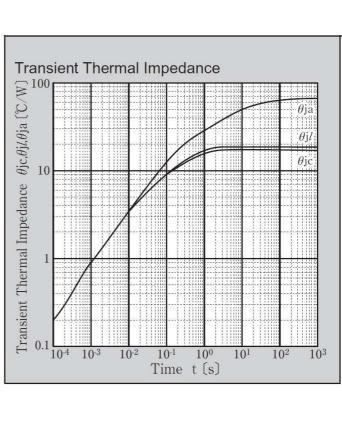








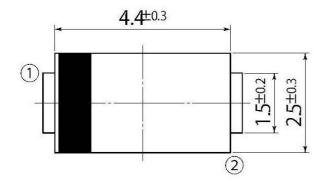


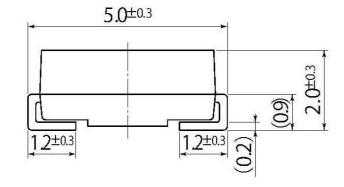


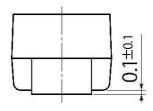
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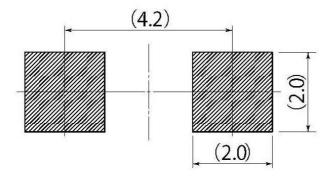
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JEDEC Code	DO-214AC		
JEITA Code	-		
House Name	1F, CF		









Referential Soldering Pad

<sup>•</sup> Optimize soldering pad to the board design and soldering condition.

#### **Notes**

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